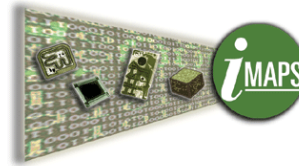


International Conference and Exhibition
on
Device Packaging

www.imaps.org/devicepackaging

Radisson Fort McDowell Resort & Casino
Scottsdale, Arizona - USA
March 17 - 20, 2008



Sponsored by
IMAPS

International Microelectronics And Packaging Society
Bringing Together the Entire Microelectronics Supply Chain!

Announcement and Call for Abstracts

Topical Workshop on

Electronic Packaging Issues for Medical Devices

This workshop is being held as a part of the Device Packaging Conference
March 17 - 20, 2008

Abstract Deadline: November 30, 2007

Technical Co-Chairs:

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Electronic Packaging Issues for Medical Devices Organizing Committee:

Vijay Varadan
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University of Arkansas
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Electronic Packaging Issues for Medical Devices Workshop Focus:

The objective of the Electronic Packaging Issues for Medical Devices Workshop is to have a forum that brings together scientists, engineers, manufacturing, academia, and business people from around the world who are working in the area of electronic packaging for various types of medical devices. This workshop has been specifically organized to allow for the presentation and discussion of the current electronic packaging trends and issues affecting a wide variety of medical applications. **Abstracts are being requested on the following topics:**

- Implantable device technology and trends
- Imaging and Biosensors
- MEMS/Nano Technology
- Hearing/Vision Aids
- Neurological Devices
- Blood Diagnostics
- Disposable Electronics
- Biometric Identification
- Wireless/RF Telemetry
- Microfluidics
- Environmental Constraints for Medical
- Biocompatibility of Materials
- Reliability Assessments
- Qualification Approaches
- RoHS Compliance & Regulations
- Outsourcing Issues

Those wishing to present in the Electronic Packaging Issues for Medical Devices sector of the Device Packaging Conference must submit a 200-300 word abstract electronically **no later than November 30, 2007**, using the on-line submittal form at: www.imaps.org/abstracts.htm. Please contact Jackki Morris-Joyner by email at jmorris@imaps.org or by phone at 305-382-8433 if you have questions.

Device Packaging Exhibit and Technology Show:

IMAPS will hold a concurrent exhibition for vendors and suppliers who support the many aspects of Electronic Packaging Issues for Medical Devices. This venue features an ideal atmosphere to showcase your products and services to key decision making professionals in the industry. Full 8' by 10' exhibit spaces will be available. To reserve booth space please fill out the on-line submittal form before February 12, 2008 at: www.imaps.org/devicepackaging or contact Ann Bell by email at abell@imaps.org or by phone at 202-548-8717.

Device Packaging Professional Development Courses (PDCs):

For those wishing to broaden their knowledge of device packaging, a selection of half-day courses will be offered on Monday, March 17th, preceding the technical conference. If you would like to participate as an instructor, please submit a description of your short course to Jackki Morris-Joyner by email at jmorris@imaps.org **no later than November 30, 2007**.